MARKING DIAGRAMS

Z00M =



### TinyLogic UHS Two-Input NAND Gate

### NC7SZ00

### **Description**

The NC7SZ00 is a single two–input NAND gate from **onsemi**'s Ultra–High Speed (UHS) series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra–high speed with high output drive while maintaining low static power dissipation over a broad  $V_{CC}$  operating range. The device is specified to operate over the 1.65 V to 5.5 V  $V_{CC}$  operating range. The inputs and output are high impedance when  $V_{CC}$  is 0 V. Inputs tolerate voltages up to 5.5 V, independent of  $V_{CC}$  operating voltage.

### **Features**

- Ultra-High Speed:  $t_{PD} = 2.4 \text{ ns}$  (Typical) into 50 pF at 5 V  $V_{CC}$
- High Output Drive: ±24 mA at 3 V V<sub>CC</sub>
- Broad V<sub>CC</sub> Operating Range: 1.65 V to 5.5 V
- Matches Performance of LCX Operated at 3.3 V V<sub>CC</sub>
- Power Down High-Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPak<sup>TM</sup> Packages
- Space-Saving SOT23-5, SC-74A and SC-88A Packages
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

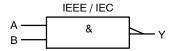


Figure 1. Logic Symbol

1

# SIP6 CASE 127EB Pin 1 VYKK XYZ Pin 1 VYKK XYZ Pin 1 SC-74A CASE 318BQ SOT23-5 CASE 527AH TZ00M 7Z00M 7Z00M

YY, 7Z00, Z00 = Specific Device Code

KK = 2-Digit Lot Run Traceability Code

SC-88A

CASE 419A-02

XY = 2-Digit Date Code Format Z = Assembly Plant Code

M = Data Code ■ Pb-Free Package

(Note: Microdot may be in either location)

### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

### **Pin Configurations**

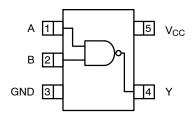


Figure 2. SOT23-5, SC-88A and SC-74A (Top View)

### A 1 6 V<sub>CC</sub> B 2 5 NC GND 3 4 Y

Figure 3. MicroPak (Top Through View)

### **PIN DEFINITIONS**

| Pin # SOT23-5,<br>SC-88A / SC74A | Pin # MicroPak | Name            | Description    |
|----------------------------------|----------------|-----------------|----------------|
| 1                                | 1              | Α               | Input          |
| 2                                | 2              | В               | Input          |
| 3                                | 3              | GND             | Ground         |
| 4                                | 4              | Υ               | Output         |
| 5                                | 6              | V <sub>CC</sub> | Supply Voltage |
|                                  | 5              | NC              | No Connect     |

### **FUNCTION TABLE**

| Inp | Output |   |
|-----|--------|---|
| Α   | В      | Υ |
| L   | L      | Н |
| L   | Н      | Н |
| Н   | L      | Н |
| Н   | Н      | L |

H = HIGH Logic Level L = LOW Logic Level

### **ABSOLUTE MAXIMUM RATINGS**

| Symbol                              | Parameter                            |                        | Min  | Max  | Unit |
|-------------------------------------|--------------------------------------|------------------------|------|------|------|
| V <sub>CC</sub>                     | Supply Voltage                       |                        | -0.5 | 6.5  | V    |
| V <sub>IN</sub>                     | DC Input Voltage                     |                        | -0.5 | 6.5  | V    |
| V <sub>OUT</sub>                    | DC Output Voltage                    |                        | -0.5 | 6.5  | V    |
| I <sub>IK</sub>                     | DC Input Diode Current               | V <sub>IN</sub> < 0 V  | -    | -50  | mA   |
| l <sub>ok</sub>                     | DC Output Diode Current              | V <sub>OUT</sub> < 0 V | -    | -50  | mA   |
| I <sub>OUT</sub>                    | DC Output Current                    |                        | -    | ±50  | mA   |
| I <sub>CC</sub> or I <sub>GND</sub> | DC V <sub>CC</sub> or Ground Current |                        | -    | ±50  | mA   |
| T <sub>STG</sub>                    | Storage Temperature Range            |                        | -65  | +150 | °C   |
| TJ                                  | Junction Temperature Under Bias      |                        | -    | +150 | °C   |
| T <sub>L</sub>                      | Junction Lead Temperature (Solde     | ering, 10 Seconds)     | -    | +260 | °C   |
| $P_{D}$                             | Power Dissipation in Still Air       | SC-74A / SOT23-5       | -    | 390  | mW   |
|                                     |                                      | SC-88A                 | -    | 332  |      |
|                                     |                                      | MicroPak-6             | -    | 812  |      |
|                                     |                                      | MicroPak2™-6           | -    | 812  |      |
| ESD                                 | Human Body Model, JEDEC: JESD22-A114 |                        | -    | 2000 | V    |
|                                     | Charge Device Model, JEDEC: JE       | ESD22-C101             | -    | 1000 |      |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### **RECOMMENDED OPERATING CONDITIONS**

| Symbol                          | Parameter                     | Conditions                            | Min  | Max             | Unit |
|---------------------------------|-------------------------------|---------------------------------------|------|-----------------|------|
| V <sub>CC</sub>                 | Supply Voltage Operating      |                                       | 1.65 | 5.5             | V    |
|                                 | Supply Voltage Data Retention |                                       | 1.5  | 5.5             |      |
| V <sub>IN</sub>                 | Input Voltage                 |                                       | 0    | 5.5             | V    |
| V <sub>OUT</sub>                | Output Voltage                |                                       | 0    | V <sub>CC</sub> | V    |
| T <sub>A</sub>                  | Operating Temperature         |                                       | -40  | +85             | °C   |
| t <sub>r</sub> , t <sub>f</sub> | Input Rise and Fall Times     | V <sub>CC</sub> = 1.8 V, 2.5 V ±0.2 V | 0    | 20              | ns/V |
|                                 |                               | V <sub>CC</sub> = 3.3 V ±0.3 V        | 0    | 10              |      |
|                                 |                               | V <sub>CC</sub> = 5.0 V ±0.5 V        | 0    | 5               |      |
| $\theta_{\sf JA}$               | Thermal Resistance            | SC-74A / SOT23-5                      | -    | 320             | °C/W |
|                                 |                               | SC-88A                                | -    | 377             |      |
|                                 |                               | MicroPak-6                            | -    | 154             |      |
|                                 |                               | MicroPak2-6                           | -    | 154             |      |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. Unused inputs must be held HIGH or LOW. They may not float.

### DC ELECTICAL CHARACTERISTICS

|                  |                           |                     |   | T                    | <u> </u> | ∘c                   | T <sub>A</sub> = -40 | to +85°C             |      |
|------------------|---------------------------|---------------------|---|----------------------|----------|----------------------|----------------------|----------------------|------|
| Symbol           | Parameter                 | V <sub>CC</sub> (V) | Conditions                                  | Min                  | Тур      | Max                  | Min                  | Max                  | Unit |
| V <sub>IH</sub>  | HIGH Level Input Voltage  | 1.65 to 1.95        |   | 0.65 V <sub>CC</sub> | _        | -                    | 0.65 V <sub>CC</sub> | -                    | V    |
|                  |                           | 2.30 to 5.50        |   | 0.70 V <sub>CC</sub> | _        | -                    | 0.70 V <sub>CC</sub> | -                    |      |
| V <sub>IL</sub>  | LOW Level Input Voltage   | 1.65 to 1.95        |   | -                    | _        | 0.35 V <sub>CC</sub> | -                    | 0.35 V <sub>CC</sub> | V    |
|                  |                           | 2.30 to 5.50        |   | -                    | _        | 0.30 V <sub>CC</sub> | -                    | 0.30 V <sub>CC</sub> | 1    |
| V <sub>OH</sub>  | HIGH Level Output Voltage | 1.65                | $V_{IN} = V_{IH}$ or $V_{IL}$ ,             | 1.55                 | 1.65     | -                    | 1.55                 | -                    | V    |
|                  |                           | 1.80                | I <sub>OH</sub> = -100 μA                   | 1.70                 | 1.80     | -                    | 1.70                 | -                    | 1    |
|                  |                           | 2.30                |   | 2.20                 | 2.30     | -                    | 2.20                 | -                    |      |
|                  |                           | 3.00                |   | 2.90                 | 3.00     | -                    | 2.90                 | -                    |      |
|                  |                           | 4.50                |   | 4.40                 | 4.50     | -                    | 4.40                 | -                    |      |
|                  |                           | 1.65                | I <sub>OH</sub> = -4 mA                     | 1.29                 | 1.52     | -                    | 1.29                 | -                    |      |
|                  |                           | 2.30                | I <sub>OH</sub> = -8 mA                     | 1.90                 | 2.15     | -                    | 1.90                 | -                    |      |
|                  |                           | 3.00                | I <sub>OH</sub> = -16 mA                    | 2.40                 | 2.80     | -                    | 2.40                 | -                    | 1    |
|                  |                           | 3.00                | I <sub>OH</sub> = -24 mA                    | 2.30                 | 2.68     | -                    | 2.30                 | -                    | 1    |
|                  |                           | 4.50                | I <sub>OH</sub> = -32 mA                    | 3.80                 | 4.20     | -                    | 3.80                 | -                    | 1    |
| V <sub>OL</sub>  | LOW Level Output Voltage  | 1.65                | $V_{IN} = V_{IH} \text{ or } V_{IL},$       | -                    | 0.00     | 0.10                 | -                    | 0.08                 | V    |
|                  |                           | 2.30                | I <sub>OL</sub> = 100 μA                    | _                    | 0.00     | 0.10                 | -                    | 0.10                 | 1    |
|                  |                           | 3.00                |   | _                    | 0.00     | 0.10                 | -                    | 0.10                 | 1    |
|                  |                           | 3.00                |   | _                    | 0.00     | 0.10                 | -                    | 0.10                 | 1    |
|                  |                           | 4.50                |   | _                    | 0.00     | 0.10                 | -                    | 0.10                 | 1    |
|                  |                           | 1.65                | I <sub>OL</sub> = 4 mA                      | -                    | 0.80     | 0.24                 | -                    | 0.24                 | 1    |
|                  |                           | 2.30                | I <sub>OL</sub> = 8 mA                      | -                    | 0.10     | 0.30                 | -                    | 0.30                 | 1    |
|                  |                           | 3.00                | I <sub>OL</sub> = 16 mA                     | -                    | 0.15     | 0.40                 | -                    | 0.40                 | 1    |
|                  |                           | 3.00                | I <sub>OL</sub> = 24 mA                     | -                    | 0.22     | 0.55                 | -                    | 0.55                 | 1    |
|                  |                           | 4.50                | I <sub>OL</sub> = 32 mA                     | -                    | 0.22     | 0.55                 | -                    | 0.55                 | 1    |
| I <sub>IN</sub>  | Input Leakage Current     | 1.65 to 5.5         | V <sub>IN</sub> = 5.5 V, GND                | -                    | _        | ±1                   | -                    | ±10                  | μΑ   |
| l <sub>OFF</sub> | Power Off Leakage Current | 0                   | V <sub>IN</sub> or V <sub>OUT</sub> = 5.5 V | _                    | _        | 1                    | _                    | 10                   | μΑ   |
| I <sub>CC</sub>  | Quiescent Supply Current  | 1.65 to 5.5         | V <sub>IN</sub> = 5.5 V, GND                | _                    | _        | 2                    | _                    | 20                   | μΑ   |

### **AC ELECTRICAL CHARACTERISTICS**

|                                     |                               |                     |                         | ٦   | Γ <sub>A</sub> = +25°C |      | T <sub>A</sub> = -40 | to +85°C |      |
|-------------------------------------|-------------------------------|---------------------|-------------------------|-----|------------------------|------|----------------------|----------|------|
| Symbol                              | Parameter                     | V <sub>CC</sub> (V) | Conditions              | Min | Тур                    | Max  | Min                  | Max      | Unit |
| t <sub>PHL</sub> , t <sub>PLH</sub> | Propagation Delay             | 1.65                | C <sub>L</sub> = 15 pF, | -   | 5.4                    | 11.4 | -                    | 12.0     | ns   |
|                                     | (Figure 4, 5)                 | 1.80                | $R_L = 1 M\Omega$       | -   | 4.5                    | 9.5  | _                    | 10.0     |      |
|                                     |                               | 2.50 ±0.20          |                         | -   | 3.0                    | 6.5  | _                    | 7.0      |      |
|                                     |                               | 3.30 ±0.30          |                         | -   | 2.4                    | 4.5  | _                    | 4.7      |      |
|                                     |                               | 5.00 ±0.50          |                         | -   | 2.0                    | 3.9  | _                    | 4.1      |      |
|                                     |                               | 3.30 ±0.30          | C <sub>L</sub> = 50 pF, | -   | 2.9                    | 5.0  | _                    | 5.2      |      |
|                                     |                               | 5.00 ±0.50          | $R_L = 500 \Omega$      | -   | 2.4                    | 4.3  | _                    | 4.5      |      |
| C <sub>IN</sub>                     | Input Capacitance             | 0.00                |                         | -   | 4                      | _    | _                    | _        | pF   |
| C <sub>PD</sub>                     | Power Dissipation Capacitance | 3.30                |                         | -   | 24                     | -    | _                    | _        | pF   |
|                                     | (Note 2) (Figure 6)           | 5.00                |                         | -   | 30                     | _    | _                    | _        |      |

<sup>2.</sup> C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression: I<sub>CCD</sub> = (C<sub>PD</sub>) (V<sub>CC</sub>) (f<sub>IN</sub>) + (I<sub>CC</sub>static).

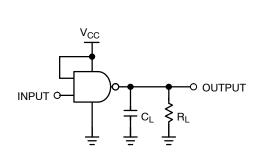


Figure 4. AC Test Circuit

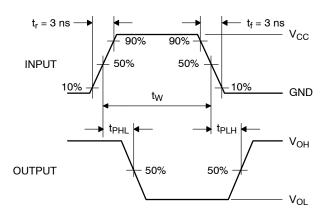
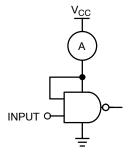


Figure 5. AC Waveforms



NOTE:

3. Input = AC Waveform;  $t_r = t_f = 1.8$  ns; PRR = 10 MHz; Duty Cycle = 50%.

Figure 6. I<sub>CCD</sub> Test Circuit

### **ORDERING INFORMATION**

| Part Number       | Top Mark | Package          | Shipping <sup>†</sup> |
|-------------------|----------|------------------|-----------------------|
| NC7SZ00M5X        | 7Z00     | SC-74A           | 3000 / Tape & Reel    |
| NC7SZ00M5X-L22090 | 7Z00     | SOT23-5          | 3000 / Tape & Reel    |
| NC7SZ00P5X        | Z00      | SC-88A           | 3000 / Tape & Reel    |
| NC7SZ00L6X        | YY       | SIP6, MicroPak   | 5000 / Tape & Reel    |
| NC7SZ00L6X-L22175 | YY       | SIP6, MicroPak   | 5000 / Tape & Reel    |
| NC7SZ00FHX        | YY       | UDFN6, MicroPak2 | 5000 / Tape & Reel    |
| NC7SZ00FHX-L22175 | YY       | UDFN6, MicroPak2 | 5000 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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**DATE 31 AUG 2016** 



NOTES:

- 1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-2009
  4. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY

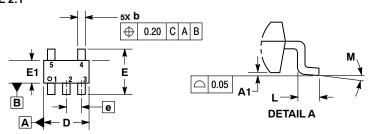
  - OTHER LINE IN THE MARK CODE LAYOUT.

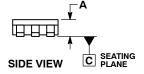
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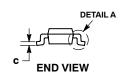
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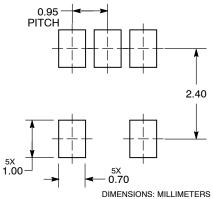
**DATE 18 JAN 2018** 







### **RECOMMENDED SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
  Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETERS.
  MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
  THICKNESS. MINIMUM LEAD THICKNESS IS THE
  MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

|     | MILLIN   | IETERS |  |
|-----|----------|--------|--|
| DIM | MIN      | MAX    |  |
| Α   | 0.90     | 1.10   |  |
| A1  | 0.01     | 0.10   |  |
| b   | 0.25     | 0.50   |  |
| С   | 0.10     | 0.26   |  |
| D   | 2.85     | 3.15   |  |
| E   | 2.50     | 3.00   |  |
| E1  | 1.35     | 1.65   |  |
| е   | 0.95 BSC |        |  |
| L   | 0.20     | 0.60   |  |
| М   | 0 °      | 10°    |  |

### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

Μ = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

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### SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE M

**DATE 11 APR 2023** 

### NOTES:

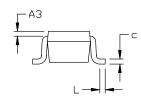
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. 419A-01 DBSDLETE, NEW STANDARD 419A-02
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
  PROTRUSIONS, OR GATE BURRS.MOLD FLASH, PROTRUSIONS,
  OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

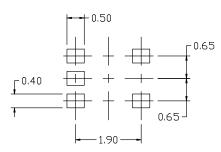
| DIM   | MILLIMETERS |      |      |
|-------|-------------|------|------|
| INITU | MIN.        | N□M. | MAX. |
| А     | 0.80        | 0.95 | 1.10 |
| A1    |             |      | 0.10 |
| A3    | 0,20 REF    |      |      |
| b     | 0.10        | 0.20 | 0.30 |
| C     | 0.10        |      | 0.25 |
| D     | 1.80        | 2.00 | 2,20 |
| Е     | 2.00        | 2.10 | 2.20 |
| E1    | 1.15        | 1.25 | 1.35 |
| е     | 0.65 BSC    |      |      |
| L     | 0.10        | 0.15 | 0.30 |

## 5 4 E1 E1 E1 E1 E1 E1



→ 0.2 M B M





### RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

### GENERIC MARKING DIAGRAM\*



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

| STYLE 1:                    |
|-----------------------------|
| PIN 1. BASE                 |
| <ol><li>EMITTER</li></ol>   |
| 3. BASE                     |
| <ol><li>COLLECTOR</li></ol> |
| <ol><li>COLLECTOR</li></ol> |
|                             |

STYLE 2:
PIN 1. ANODE
2. EMITTER
3. BASE
4. COLLECTOR
5. CATHODE

STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. CATHODE 1 STYLE 4:
PIN 1. SOURCE 1
2. DRAIN 1/2
3. SOURCE 1
4. GATE 1
5. GATE 2

STYLE 5: PIN 1. CATHODE 2. COMMON ANODE 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4

STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR STYLE 7:
PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 8:
PIN 1. CATHODE
2. COLLECTOR
3. N/C
4. BASE
5. EMITTER

STYLE 9: PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE 5. ANODE Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

### **DOCUMENT NUMBER:**

98ASB42984B

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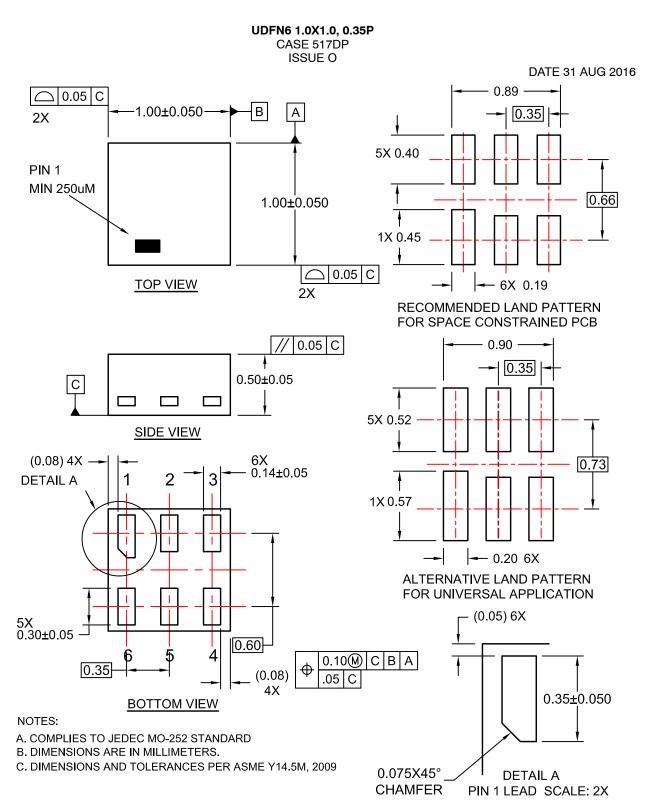
**DESCRIPTION:** 

5. COLLECTOR 2/BASE 1

SC-88A (SC-70-5/SOT-353)

PAGE 1 OF 1

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|------------------|----------------------|---|-------------|
| DESCRIPTION:     | UDFN6 1.0X1.0, 0.35P |   | PAGE 1 OF 1 |

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REFERENCE



A

F1 F

В

**DATE 09 JUN 2021** 

### NUTES

DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 19894

DIM

- CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS, MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.25 PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM D.

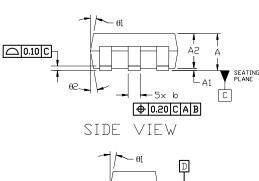
MIN.

DIMENSION 'b' DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL BE O. 08mm TOTAL IN EXCESS OF THE 'b' DIMENSION AT MAXIMUM MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07mm.

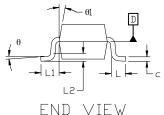
MILLIMETERS

ИПМ.

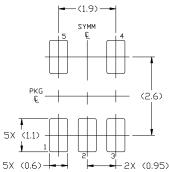
MAX.



TOP VIEW



### Α 0.90 1.45 A1 0.00 0.15 Α2 0.90 1.15 1.30 b 0.30 0.50 0.08 0.22 n 2.90 BSC 2.80 BSC E1 1.60 BSC 0.95 BSC е 0.45 0.30 0.60 L1 0.60 REF 0.25 REF L2 4° θ 0° 10° 15° θ1 0° 10° θ2 15°



### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

### RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the  $\square N$  Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|------------------|----------------|---|-------------|
| DESCRIPTION:     | SOT-23, 5 LEAD |   | PAGE 1 OF 1 |

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